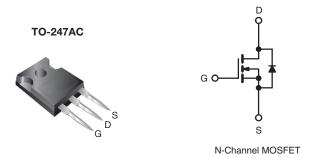


## **Power MOSFET**

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	400			
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V	0.55		
Q <sub>g</sub> (Max.) (nC)	62			
Q <sub>gs</sub> (nC)	10			
Q <sub>gd</sub> (nC)	30			
Configuration	Single			



### **FEATURES**

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Isolated Central Mounting Hole
- · Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC



#### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-247AC package is preferred for commercial-industrial applications where higher power levels preclude the use of TO-220AB devices. The TO-247AC is similar but superior to the earlier TO-218 package because its isolated mounting hole. It also provides greater creepage distances between pins to meet the requirements of most safety specifications.

ORDERING INFORMATION		
Package	TO-247AC	
Lead (Pb)-free	IRFP340PbF	
	SiHFP340-E3	
SnPb	IRFP340	
	SiHFP340	

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub> = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			$V_{DS}$	400	V	
Gate-Source Voltage			$V_{GS}$	± 20		
Continuous Drain Current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C	,	11		
	VGS at 10 V	T <sub>C</sub> = 100 °C	ID	6.9	Α	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	44		
Linear Derating Factor				1.2	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	480	mJ	
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	11	Α	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	15	mJ	
Maximum Power Dissipation	T <sub>C</sub> = 25 °C		$P_{D}$	150	W	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	4.0	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature)	for 10 s			300 <sup>d</sup>		
Mounting Torque	6-32 or M3 screw			10	lbf ⋅ in	
				1.1	N⋅m	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 6.9 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 11 A (see fig. 12).
- c.  $I_{SD} \le 11$  A,  $dI/dt \le 120$  A/ $\mu$ s,  $V_{DD} \le V_{DS}$ ,  $T_J \le 150$  °C.
- d. 1.6 mm from case.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply



THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	40		
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.24	-	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	0.83		

PARAMETER	SYMBOL	TEST	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0	400	-	-	V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference t	Reference to 25 °C, I <sub>D</sub> = 1 mA			-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V$	<sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>GS</sub> = ± 20 V		-	-	± 100	nA
7 0 1 1/1 1 2 1 2 1		V <sub>DS</sub> = 40	V <sub>DS</sub> = 400 V, V <sub>GS</sub> = 0 V		-	25	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 320 V, V	/ <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	250	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 6.6 A <sup>b</sup>	-	-	0.55	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 50 V, I <sub>D</sub> = 6.6 A <sup>b</sup>		7.7	-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ $f = 1.0 \text{ MHz, see fig. 5}$		-	1400	-	pF
Output Capacitance	Coss			-	400	-	
Reverse Transfer Capacitance	C <sub>rss</sub>			-	130	-	
Total Gate Charge	Qg		V <sub>GS</sub> = 10 V	-	-	62	nC
Gate-Source Charge	$Q_{gs}$	V <sub>GS</sub> = 10 V		-	-	10	
Gate-Drain Charge	Q <sub>gd</sub>		l see ng. e and re	-	-	30	
Turn-On Delay Time	t <sub>d(on)</sub>			-	14	-	- ns
Rise Time	t <sub>r</sub>	V <sub>22</sub> = 20	V <sub>DD</sub> = 200 V, I <sub>D</sub> = 10 A ,		27	-	
Turn-Off Delay Time	t <sub>d(off)</sub>	$R_{\rm g} = 9.1 \ \Omega, \ R_{\rm D} = 200 \ \Omega, \ {\rm see \ fig. \ 10^b}$		-	50	-	
Fall Time	t <sub>f</sub>			-	24	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	5.0	-	
Internal Source Inductance	L <sub>S</sub>			-	13	-	- nH
Drain-Source Body Diode Characteristic	s				·		
Continuous Source-Drain Diode Current	Is	MOSFET symbol showing the integral reverse p - n junction diode		ı	-	11	- A
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			I	-	44	
Body Diode Voltage	$V_{SD}$	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 11 A, V <sub>GS</sub> = 0 V <sup>b</sup>		-	-	2.0	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	- T <sub>J</sub> = 25 °C, I <sub>F</sub> = 10 A, dl/dt = 100 A/μs <sup>b</sup>		ı	330	660	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	2.5	5.9	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-	rn-on is dominated by L <sub>S</sub> and L <sub>D</sub> )				

### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq 300~\mu s;$  duty cycle  $\leq 2~\%.$



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

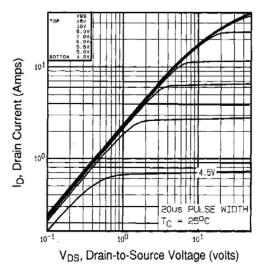


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

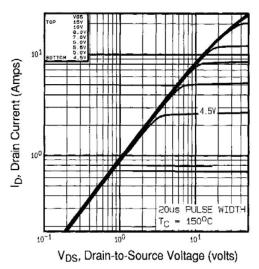


Fig. 2 - Typical Output Characteristics, T<sub>C</sub> = 150 °C

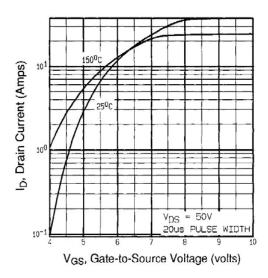


Fig. 3 - Typical Transfer Characteristics

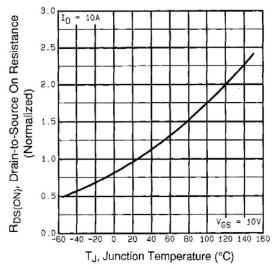


Fig. 4 - Normalized On-Resistance vs. Temperature



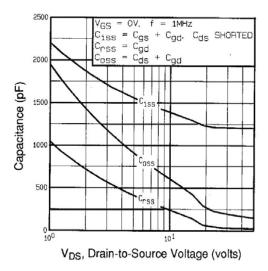


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

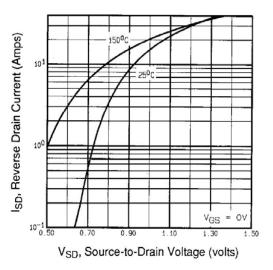


Fig. 7 - Typical Source-Drain Diode Forward Voltage

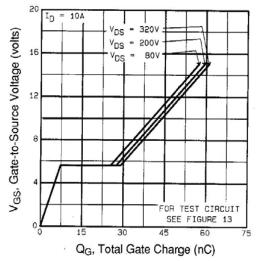


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

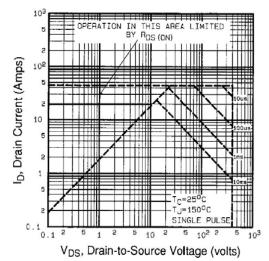


Fig. 8 - Maximum Safe Operating Area





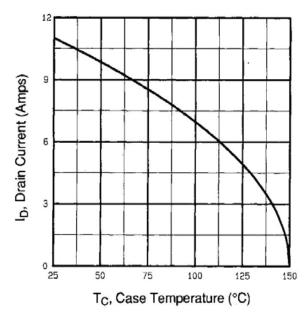


Fig. 9 - Maximum Drain Current vs. Case Temperature

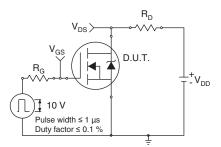


Fig. 10a - Switching Time Test Circuit

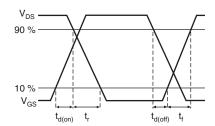


Fig. 10b - Switching Time Waveforms

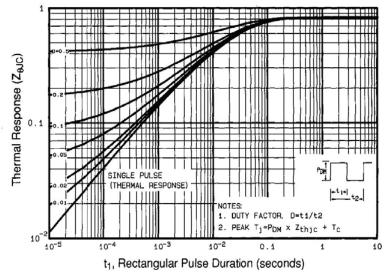


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



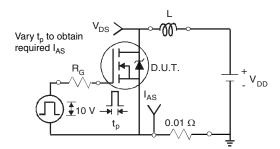


Fig. 12a - Unclamped Inductive Test Circuit

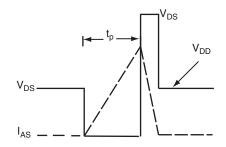


Fig. 12b - Unclamped Inductive Waveforms

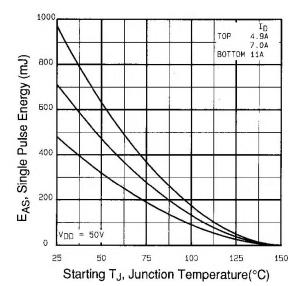


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

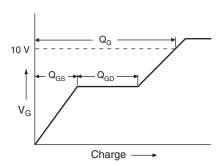


Fig. 13a - Basic Gate Charge Waveform

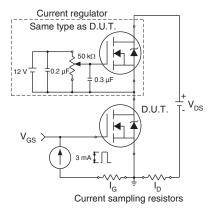
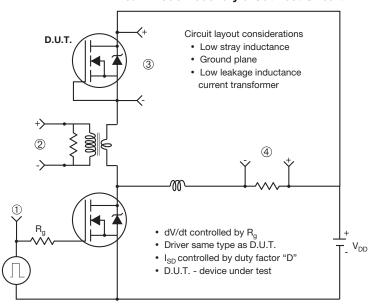


Fig. 13b - Gate Charge Test Circuit



#### Peak Diode Recovery dV/dt Test Circuit



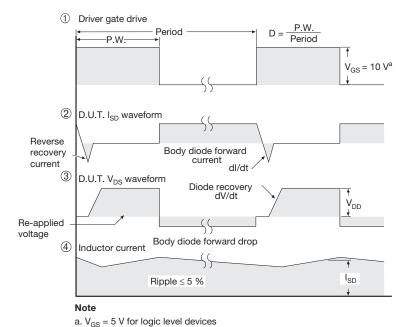


Fig. 14 - For N-Channel

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Document Number: 91000 www.vishay.com
Revision: 11-Mar-11 1